

Stability and Elastic, Electronic, and Thermodynamic Properties of $\mathsf{Fe_{2}TiSi_{1-x}Sn_{x}{}$ Compounds

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We have systematically studied the structural, phase, and mechanical stability and elastic, electronic, and thermodynamic properties of $\rm Fe_2TiSi_{1-x}Sn_{x}$ $(x = 0, 0.25, 0.5, 0.75, 1)$ compounds using first-principles calculations. The structural and phase stability and elastic properties of $Fe_2TiSi_{1-x}Sn_x$ ($x = 0$, 0.25, 0.5, 0.75, 1) indicated that all of the compounds are thermodynamically and mechanically stable. The shear modulus, bulk modulus, Young's modulus, Poisson's ratio, electronic band structure, density of states, Debye temperature, and Grüneisen parameter of all the substituted compounds were studied. The results show that Sn substitution in $Fe₂TiSi$ enhances its stability and mechanical and thermoelectric properties. The $\rm Fe_2TiSi_{1-x}Sn_{x}$ compounds have narrow bandgap from 0.144 eV and 0.472 eV for Sn substitution from 0 to 1. The calculated band structure and density of states (DOS) of $\rm Fe_2TiSi_{1-x}Sn_{x}$ show that the thermoelectric properties can be improved at substituent concentration x of 0.75. The lattice thermal conductivity was significantly decreased in the Sn-substituted compounds, and all the results indicate that $Fe₂TiSi_{0.25}Sn_{0.75}$ could be a new candidate high-performance thermoelectric material.

Key words: Full-Heusler, Fe₂TiSi, Fe₂TiSn, Fe₂TiSi_{1-x}Sn_x, thermoelectric, first principles

INTRODUCTION

Solid-state thermoelectric (TE) energy conversion is a promising and useful technology for both electric power generation from waste heat and cooling of various electronic devices, and this technology is expected to play a fundamental role in solving today's energy and environmental issues.^{[1](#page-5-0)} At present, one of the most well-known thermoelectric materials used in thermoelectric cooling devices is Bi_2Te_3 -based alloy, having maximum ZT of around $1²$ $1²$ $1²$ Other materials with high ZT, such as $\mathrm{In}_4\mathrm{Se}_{3-\delta},$ filled skutterudite antimonides, Ag $\mathrm{Pb}_m\mathrm{Sb}$ - Te_{2+m} , Tl-doped PbTe, and Ag₉TlTe₅, have also been studied recently as next-generation advanced

thermoelectric materials. $3-8$ However, these compounds include toxic and scarce elements such as tellurium, antimony, and thallium, so it is important to develop new materials that consist of predominantly abundant and nontoxic elements and that can be obtained using relatively uncomplicated fabrication techniques. $Fe₂XY$ Heusler compounds are good candidates for use in thermoelectric applications, and theoretical investigations have been carried out on Fe-based Heusler compounds using first-principle calculations, yielding power factors 4 to 5 times larger than those of classical thermoelectric materials at room temperature. Among these compounds, $Fe₂VAL$ with Heusler-type structure is one of the most prominent examples because of its high thermoelectric power factor, and this material has been studied by many Received February 28, 2017; accepted April 28, 2017; Tactor, and this material has been studied by many
published online May 10, 2017) scientists.^{[10–12](#page-6-0)} Fe_2TiSn and Fe_2TiSi compounds,

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which also belong to the group of $Fe₂XY$ Heusler compounds, are promising candidate nontoxic and inexpensive thermoelectric materials, and previous theoretical investigations have shown that they possess high Seebeck coefficient from -300μ V K⁻¹ to $-160 \mu \text{V K}^{-1}$ around room temperature.^{[13](#page-6-0)} The electronic structure and magnetic properties of $Fe₂TiSn$ and $Fe₂TiSi$ have been studied theoretically, and their physical and thermoelectric properties including elastic and electronic properties, electrical conductivity, Seebeck coefficient, as well as thermal conductivity, second conductivity studied.^{[14–20](#page-6-0)} The Heusler compound Fe2TiSi is confirmed experimentally to be a semiconductor with gap of 0.4 eV, having potential for use in thermoelectric applications. 14 14 14 Lue et al. observed a Seebeck coefficient for $Fe₂TiSn$ at around 340 K compatible with that of $Fe₂VAL$ (at 300 K , 15 15 15 and Shin et al. predicted that the temperature dependence of the thermoelectric properties can be tuned by substitution with Si. However, no reports are available on ${\rm Fe_2TiSi}_{1-x}{\rm Sn}_x$ in literature, except for $x = 0$ and 1. To enhance the thermoelectric performance of $Fe₂TiSi$ and $Fe₂TiSn$, we calculated and systematically studied the structural, phase, and mechanical stability as well as the elastic, electronic, and thermodynamic properties of $Fe₂TiSi_{1-x}Sn_x$ (x = 0, 0.25, 0.5, 0.75, 1) compounds. The results indicate that Sn substitution at $x = 0.75$ in Fe₂TiSi improves the thermoelectric performance by adjusting the bandgap and significantly decreasing the lattice thermal conductivity. Our results are not only interesting from a fundamental point of view but could also be significant in the search for new candidate high-performance full-Heusler thermoelectric materials.

COMPUTATIONAL PROCEDURES

The crystal structure of $Fe₂TiX$ (X = Si, Sn) is in space group $Fm-3m$ (no. 225). There are 16 atoms in the unit cell of the Heusler compounds $Fe₂TiX$ $(X = Si, Sn)$. The Ti and Si atoms occupy two facecentered cubic (fcc) sublattices with origin at 4a (0, 0, 0) and 4b (1/2, 1/2, 1/2), respectively. The Fe atoms are located on 8c (1/4, 1/4, 1/4) sublattices, and each Fe atom has four Ti and four X atoms as nearest neighbors, while each Ti and X atom is surrounded by eight Fe atoms. For the nonstoichiometric compounds $Fe₂TiSi_{1-x}Sn_x$ ($x = 0, 0.25, 0.5,$ 0.75, 1), we used a conventional unit cell with 16 atoms (i.e., $Fe_8Ti_4X_4$), where alloying was performed by partial substitution of Si atom by Sn. This substitution was tested at four different sites of Si atom in the crystal by calculating the total energy for each case, but the difference was negligible and did not affect the results. The total energy, electronic structure, and elastic properties of the materials were studied using the Cambridge Serial Total Energy Package $(CA\widetilde{STEP})$,^{[21](#page-6-0)} based on density functional theory (DFT) in the generalized gradient approximation (GGA) with the Perdew–Burke–

Ernzerhof $(PBE)^{22}$ $(PBE)^{22}$ $(PBE)^{22}$ exchange–correlation potential. All calculations were continued until the maximum force on atoms was below 0.01 eV/A , the maximum displacement between cycles was below $5.0 \times$ 10^{-4} Å, and the energy change was below 5.0 \times 10⁻⁶ eV/atom. Periodic boundary conditions were applied, enabling expansion of the crystal wavefunction in terms of a plane-wave basis set. After a series of tests, the cutoff energy was set as 360 eV and the ultrasoft pseudopotential was chosen to describe the interaction of electrons between valence states and core states with the electron configurations for Fe, Ti, Si, and Sn atoms represented as $3d^6$ $4s^2, 3s^2\,3p^6\,3d^2\,4s^2, 3s^2\,3p^2,$ and $5s^2\,5p^2,$ respectively. We used $8 \times 8 \times 8$ k-points according to the Mon-khorst–Pack scheme^{[23](#page-6-0)} in the Brillouin zone for integrations, based on the Broyden–Fletcher–Goldfarb–Shenno $(BFGS)^{24}$ $(BFGS)^{24}$ $(BFGS)^{24}$ minimization technique. For a given atomic arrangement, the lattice parameters and atom positions were optimized to minimize the total energy, and the system was considered to have reached the ground state via self-consistent calculation when the total energy was stable within 5×10^{-7} eV/atom. We used a quasiharmonic Debye model to obtain the thermodynamic properties.

RESULTS AND DISCUSSION

Stability and Elastic Properties

We theoretically calculated the lattice constant of $Fe₂TiSi_{1-x}Sn_x (x = 0, 0.25, 0.5, 0.75, 1) by minimiz$ ing the total energy using first-principle calculations; the optimized lattice constant for $Fe₂TiSi$ and $Fe₂TiSn$ is 5.658 Å and 6.032 Å, respectively (Table [I](#page-2-0)). The differences from experimental results are smaller than $1\%,^{14,25}$ $1\%,^{14,25}$ $1\%,^{14,25}$ indicating that the present calculations are highly reliable. If thermodynamic effects on the crystal structure are considered, our calculation results should be in good agreement with experimental results, and we can conclude that the computational parameters and conditions selected in this study are therefore suitable.

The enthalpy of formation, which determines the bulk stability of a compound, is defined as the difference between its total energy and the sum of the total energies of its constituents in their corresponding proportions. Generally, negative enthalpy of formation implies that the structure is thermodynamically stable, while a positive value means that the structure is unstable. To investigate the thermodynamic stability of $Fe_2TiSi_{1-x}Sn_x$ (x = 0, $0.25, 0.5, 0.75, 1$, the enthalpy of formation was calculated as

$$
\Delta H_{\text{Fe}_8\text{Ti}_4\text{Si}_n\text{Sn}_{4-n}} = (E_{\text{Fe}_8\text{Ti}_4\text{Si}_n\text{Sn}_{4-n}}^{\text{tot}} - 8E_{\text{Fe}}^{\text{bulk}} - 4E_{\text{Ti}}^{\text{bulk}} - nE_{\text{Si}}^{\text{bulk}} - (4 - n)E_{\text{Sn}}^{\text{bulk}})/16, \tag{1}
$$

where $E_{\text{Fe}_3\text{Ti}_3\text{Si}_n\text{Sn}_{4-n}}^{\text{tot}}$ is the total energy of the compound $\widetilde{\mathrm{Fe}}_8 \widetilde{\mathrm{Ti}}_4 \widetilde{\mathrm{Si}}_n \mathrm{Sn}_{4-n}$, and $E_{\mathrm{Fe}}^{\mathrm{bulk}}$, $E_{\mathrm{Ti}}^{\mathrm{bulk}}$, $E_{\mathrm{Si}}^{\mathrm{bulk}}$,

and density (d) of

and $E^{\rm bulk}_{\rm Sn}$ are the total energies of the pure elements in their bulk state; n is 4, 3, 2, 1, and 0 for $x = 0$, 0.25, 0.5, 0.75, and 1, respectively. The enthalpy of formation for the $Fe₂TiSi_{1-x}Sn_x$ ($x = 0, 0.25, 0.5,$ 0.75, 1) compounds is summarized together with their optimized ground-state lattice parameter and density in Table I.

It is clear that the enthalpy of all the $Fe₂Ti \mathrm{Si}_{1-x}\mathrm{Sn}_{x}$ (x = 0, 0.25, 0.5, 0.75, 1) compounds was negative, confirming the thermodynamic stability of these structures. The lattice parameter and density increased with increasing x , indicating greater thermodynamic stability with increasing Sn substitution.

The elastic properties of a material are amongst the most important physical properties related to its structure and mechanical stability, in addition to some other fundamentally important properties. We therefore studied the elastic properties of the substituted compounds with different amounts of substitution of Si by Sn atoms. According to the unit cell of Fe2TiSi, we chose substituent concentrations of $x = 0.25, 0.5, \text{ and } 0.75 \text{ in } \text{Fe}_2 \text{TiSi}_{1-x} \text{Sn}_x, \text{correspond}$ ing to one, two, or three Si atoms substituted by Sn atoms in the Fe₂TiSi unit cell. For $x = 0.5$, the primitive cell of $Fe₂TiSi_{0.5}Sn_{0.5} contains six atoms$ and has tetragonal structure in space group P4/ mmm (no. 123). The elastic constants C_{ij} for the $Fe₂TiSi_{1-x}Sn_x (x = 0, 0.25, 0.5, 0.75, 1) compounds$ as obtained from ground-state total energy calculations are presented in Table II.

There are five independent elastic constants at $x = 0.5$ due to the tetragonal symmetry, while the other compounds $(x = 0, 0.25, 0.75,$ and 1) have only three independent elastic constants. None of the C_{ij} values are negative. The conditions for mechanical stability of cubic crystals at equilibrium are traditionally expressed in terms of the elastic constants as follows: $C_{11} > 0$, $C_{33} > 0$, $C_{44} > 0$, $C_{66} > 0$, $(C_{11} - C_{12}) > 0$, $(C_{11} + C_{33} - 2C_{13}) > 0$, $[2(C_{11} +$ C_{12}) + C_{33} + $4C_{33}$] > 0. The calculated elastic con-stants in Table [III](#page-3-0) show that the $Fe_2TiSi_{1-x}Sn_x$ $(x = 0, 0.25, 0.5, 0.75, 1)$ compounds are mechanically stable according to these stability criteria.

One can therefore calculate the other mechanical properties for these materials using the Voigt– Reuss–Hill (VRH) approximation. From the calculated elastic constants, the shear modulus G, bulk modulus B , and Young's modulus E can be estimated as follows: $B=(B_{\rm V}+B_{\rm R})/2, \; G=(G_{\rm V}+G_{\rm R})/2,$ and $E = 9BG/(3B + G)$, where B_V , B_R , G_V , and G_R can be calculated as follows^{[26](#page-6-0)}:

$$
B_V = [2(C_{11} + C_{12}) + C_{33} + 4C_{13}]/9, \qquad (2)
$$

$$
B_{\rm R} = \frac{[(C_{11} + C_{12})C_{33} - 2C_{13}^2]/(C_{11} + C_{12} \times 2C_{33} - 4C_{13}), \tag{3}
$$

$$
G_V = [M + 3C_{11} - 3C_{12} + 12C_{44} + 6C_{66}]/30, \quad (4)
$$

$$
G_{\rm R} = 15 / \{ (18B_{\rm V}/C^2) + [6/(C_{11} - C_{12})] + 6/C_{44} \over + 3/C_{66} \}, \tag{5}
$$

$$
M = C_{11} + C_{12} + 2C_{33} - 4C_{13},
$$

\n
$$
C^2 = (C_{11} + C_{12})C_{33} - 2C_{13}^2.
$$
\n(6)

The calculated shear modulus G , bulk modulus B , and Young's modulus E are presented in Table [III.](#page-3-0)

v
0.221
0.231
0.229
0.238
0.251

Table III. Bulk modulus B, shear modulus G, Young's modulus E, B/G, and Poisson's ratio of ${\rm Fe_2TiSi_{1-x}Sn_{x}}$ $(x = 0, 0.25, 0.5, 0.75, 1)$

The obtained values also obey the cubic stability condition: $C_{12} < B < C_{11}$, suggesting mechanical stability. Generally, the Young's modulus of a material is used to characterize its stiffness; materials with higher E are stiffer. Furthermore, the ratio of the bulk to shear modulus of crystalline phases can also predict their brittle or ductile behavior. Higher (lower) B/G ratio corresponds to ductile (brittle) behavior, the critical value which separates ductile from brittle materials being around 1.75. The values in Table III show that the ${\rm Fe}_2 {\rm TiSi}_{1-x}{\rm Sn}_x$ compounds become more ductile with increasing Sn substitution. We also calculated the Poisson ratio of the materials, as listed in Table III. This ratio can be used to quantify the stability of a crystal against shear, with most materials having values between 0.0 and 0.5. The Poisson ratio values of these materials reveal that the $Fe₂TiSi_{1-x}Sn_x$ compounds are mechanically stable and that their stability against shear is not weak. All these results confirm that Sn substitution is advantageous to enhance the stability and mechanical properties of these compounds.

Electronic Properties

The features of the band structure near the Fermi level determine the thermoelectric properties of a material, which are very useful to obtain reliable transport property values for thermoelectric materials. To theoretically investigate the electronic properties of the $\text{Fe}_2 \text{TiSi}_{1-x} \text{Sn}_x$ (x = 0, 0.25, 0.75, 1) compounds, band-structure calculations were performed, as shown in Fig. 1.

As shown in Fig. 1, the electronic band structures of the $\rm Fe_2TiSi_{1-x}Sn_{x}$ compounds show similar trends, but their conduction-band bottom shifted away from the Fermi level as the Sn content x was decreased. The $\rm Fe_2TiSi_{1-x}Sn_{x}$ compounds are semiconductors with flat band at the bottom of the conduction band along G–X direction. The valenceband maximum and conduction-band minimum (at the G point) mainly consist of Fe 3d (t_{2g}) orbitals and Fe $3d$ (e_g) orbitals, respectively. The bandgaps in these band structures are well consistent with previous results of 0.144 eV for Fe₂TiSn and 0.472 eV for Fe₂TiSi.^{[13,14](#page-6-0)} Figure 2 illustrates the change in the bandgap with the substituent concentration x.

Fig. 2. Bandgap of $Fe₂TiSi_{1-x}Sn_x$ versus substituent concentration x.

Figure 2 shows that the $Fe_2TiSi_{1-x}Sn_x$ compounds have narrow bandgap values from 0.144 eV and 0.472 eV for Sn content ranging from 0 to 1. In previous research, the temperature dependence of the Seebeck coefficient S for different bandgaps was studied for $Fe₂TiSi$ and $Fe₂TiSn$ materials, 13 13 13 indicating that the absolute S value at 300 K was stable and did not change when the bandgap was wider than 0.2 eV. As shown in Fig. 2, this condition is satisfied for substituent

Fig. 3. Total density of states (TDOS) of $Fe_2TiSi_{1-x}Sn_x$ ($x = 0$, 0.25, 0.5, 0.75, 1).

concentration of 0.75 or less. For deeper understanding of the electronic properties, the total and partial densities of states (TDOS and PDOS) were investigated. The total density of states (TDOS) near the Fermi level for the $Fe_2TiSi_{1-x}Sn_x$ compounds is shown in Fig. 3. Figure 4 presents the total DOS, local density of states (LDOS), and partial densities of states (PDOS) of the $Fe₂Ti \mathrm{Si}_{0.25}\mathrm{Sn}_{0.75}$ compound near the Fermi level.

The pattern of the DOS distribution of the $Fe₂TiSi_{1-x}Sn_x (x = 0, 0.25, 0.5, 0.75, 1) compounds$ is almost the same, but the detailed energy peak and band regions are not. The main contributions to the DOS near the Fermi level of these materials come from the d orbitals of Fe and Ti. The calculated band structure and DOS predict that these compounds have electronic structure with a narrow pseudogap at the Fermi energy. Lower DOS at the Fermi level and steeper DOS will lead to larger Seebeck coefficient according to the Mott approxi-mation.^{[27](#page-6-0)} In $\text{Fe}_2 \text{TiSi}_{1-x} \text{Sn}_x$ ($x = 0, 0.25, 0.5, 0.75, 1$) compounds, the slope of the DOS between the Fermi level and band top is slightly larger when x is bigger, and the DOS at the Fermi energy decreases slightly as the Sn substituent concentration x is increased. The calculated band structure and DOS of the $Fe_2TiSi_{1-x}Sn_x$ ($x = 0$, 0.25, 0.5, 0.75, 1) compounds show that the thermoelectric properties could be improved for substituent concentration x of 0.75.

Thermodynamic Properties

To improve the performance of thermoelectric materials, they should have large figure of merit $ZT = S^2T\sigma/\kappa$, where σ , S, T, and κ are the electrical conductivity, Seebeck coefficient, absolute tempera-ture, and thermal conductivity, respectively.^{[1](#page-5-0)[,2](#page-6-0)} Therefore, to investigate whether a material could be a candidate for use in thermoelectric applications, one needs to investigate its thermal conductivity. The total thermal conductivity of a material includes both electronic thermal conductivity and lattice thermal conductivity. Previously reported experimental results show that the thermal conductivity of $Fe₂TiSn$ mainly originates from the lattice component κ_1 .^{[15](#page-6-0)} Thus, a large reduction in κ_1 is needed to enhance the thermoelectric performance. The lattice thermal conductivity can be obtained using the Debye temperature (Θ_D) and the Grüneisen parameter (y) as²

$$
\kappa_{\rm l}(T) = \frac{0.617\theta_{\rm D}^3k_{\rm B}^3mV^{1/3}}{(1-0.514\gamma^{-1}+0.228\gamma^{-2})nh^3\gamma^2T},\qquad(7)
$$

where *n* is the number of atoms in the unit cell, k_B is the Boltzmann constant, V is the volume of the unit cell, and m is the average atomic mass. If the elastic constants and electronic structures of the compound are known, one can estimate the Debye temperature and Grüneisen parameter from the average sound velocity using the following equations:

$$
\theta_{\rm D} = \frac{h v_{\rm m}}{k_{\rm B}} \left[\frac{3n}{4\pi} \left(\frac{\rho N_{\rm A}}{M_{\rm m}} \right) \right]^{\frac{1}{3}},\tag{8}
$$

$$
\gamma = \frac{9}{2} \left(\frac{v_1^2 - 4v_t^2/3}{v_1^2 + 2v_t^2} \right),\tag{9}
$$

Table IV. Calculated transverse (v_t) , longitudinal (v_l) , and mean sound speeds (v_m) , Grüneisen parameter (γ) , and Debye temperature (Θ_{D}) for $Fe_2TiSi_{1-x}Sn_x$ (x = 0, 0.25, 0.5, 0.75, 1)

$\pmb{\mathcal{X}}$ \sim	v_1 (m/s)	$v_{\rm t}$ (m/s)	$v_{\rm m}$ (m/s)		$\mathbf{\Theta}_{\mathbf{D}}(\mathbf{K})$
0	8096.0	4813.4	5329.5	1.394	705.117
0.25	7586.5	4486.4	4970.0	1.413	647.181
0.5	7145.4	4237.0	4692.4	1.403	601.130
0.75	6794.6	3984.6	4417.5	1.444	557.703
	6439.6	3710.4	4120.0	$1.507\,$	512.228

where k_B is the Boltzmann constant, h is the Planck constant, ρ is the density of the material, N_A is Avogadro's number, and M_m is the molecular weight. v_m is the mean sound velocity, which can be calculated from v_1 (longitudinal elastic wave velocity) and v_t (transverse elastic wave velocity), which are related to the bulk modulus and shear modulus by Navier's equation 34 :

$$
v_{\rm m} = \left[\frac{1}{3}\left(\frac{2}{v_{\rm t}^3} + \frac{1}{v_{\rm l}^3}\right)\right]^{-\frac{1}{3}}, \quad v_{\rm l} = \left(\frac{B + \frac{4G}{3}}{\rho}\right)^{\frac{1}{2}}, \text{and}
$$

$$
v_{\rm t} = \left(\frac{G}{\rho}\right)^{\frac{1}{2}}.
$$
 (10)

The calculated values of v_m , v_l , v_t , Θ_D , and γ for the $Fe_2TiSi_{1-x}Sn_x$ ($x = 0, 0.25, 0.5, 0.75, 1$) compounds are presented in Table IV.

Based on the above formula, we calculated the lattice thermal conductivity of $\text{Fe}_2 \text{TiSi}_{1-x} \text{Sn}_x$ ($x = 0$, 0.25, 0.5, 0.75, 1) and show the results in Fig. 5.

The lattice thermal conductivity of $\rm Fe_2TiSi_{1-x}Sn_{x}$ $(x = 0, 0.25, 0.5, 0.75, 1)$ decreases with increasing temperature. Fe $_2$ TiSi has higher lattice thermal conductivity than $Fe₂TiSn$, due to the heavier Sn atoms. The κ_1 values of the substituted compounds are lower than that of the pure compound, because Sn substitution increases the phonon scattering centers. Our calculations are, of course, approximate and somewhat simplistic to clarify the precise thermodynamic properties of $\rm Fe_2TiSi_{1-x}Sn_x,$ but the tendencies can be considered to be reliable and supported with sufficient evidence.

CONCLUSIONS

We systematically studied the structural, phase, and mechanical stability as well as the elastic, electronic, and thermodynamic properties of Fe2Ti- $\mathrm{Si}_{1-x}\mathrm{Sn}_{x}$ (x = 0, 0.25, 0.5, 0.75, 1) compounds using first-principles calculations. The following conclusions can be drawn:

- 1. The structural and phase stability, and elastic properties (shear modulus, bulk modulus, Young's modulus, and Poisson's ratio) of the $Fe₂TiSi_{1-x}Sn_x$ (x = 0, 0.25, 0.5, 0.75, 1) compounds were studied; the results indicate that all of the compounds are thermodynamically and mechanically stable, and Sn substitution in Fe2TiSi enhances its stability and mechanical properties.
- 2. The electronic band structure, DOS, and charge density distribution were researched, indicating that the ${\rm Fe_2TiSi}_{1-x}{\rm Sn}_x$ compounds have narrow bandgaps from 0.144 eV to 0.472 eV for Sn substitution ranging from 0 to 1. The calculated band structure and DOS of $\rm Fe_2TiSi_{1-x}Sn_{x}$ show that the thermoelectric properties could be improved at substituent concentration x of 0.75.
- 3. The thermodynamic properties of the $Fe₂Ti$ - $\mathrm{Si}_{1-x}\mathrm{Sn}_{x}$ compounds were studied, revealing that the lattice thermal conductivity was significantly decreased in the Sn-substituted compounds. All the results indicate that $Fe₂TiSi_{0.25}Sn_{0.75}$ could be a new candidate high-performance thermoelectric material.

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